

PRODUCT DATASHEET Tina2 series

last update 26/11/2013

DETAILS

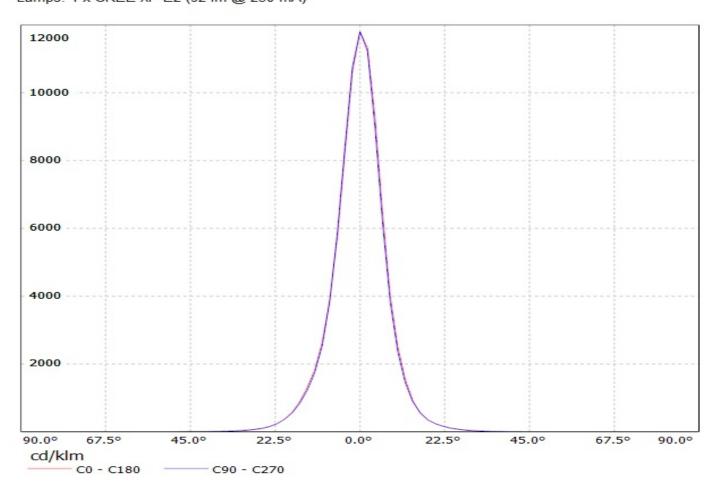
Product Number CA11420_TINA2-D

Family Tina2 Type Assembly Color black Diameter 16,1 mm Height 9,66 mm Style round **PMMA Optic Material Holder Material** РС Fastening tape Status ready **ROHS Comliant** Yes **Date Updated** 14/11/2012

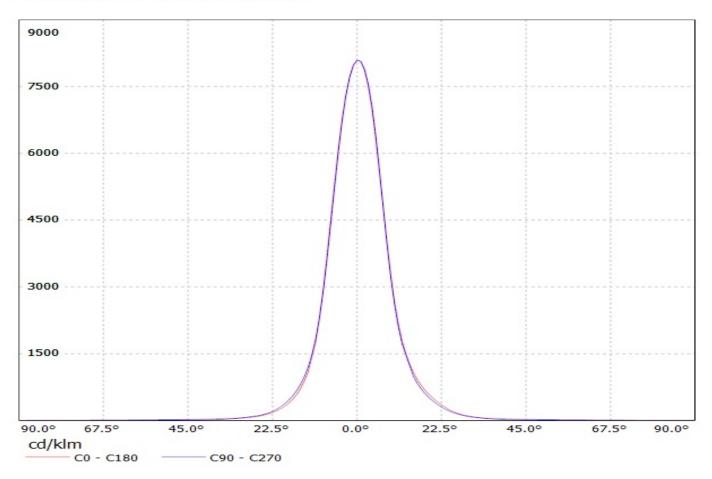
OPTICAL PROPERTIES

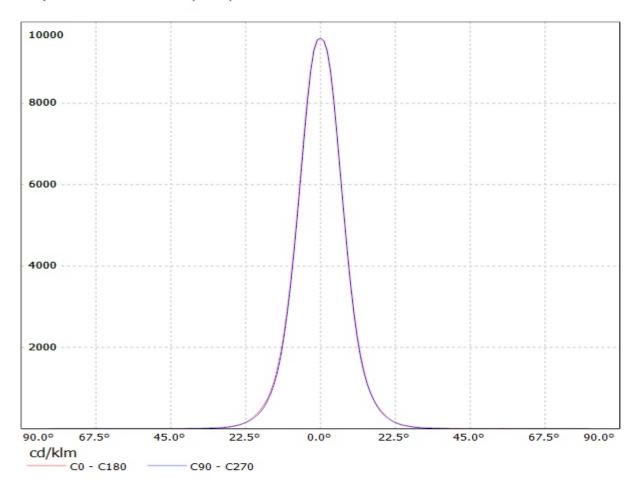
	Viewing	Light	Effi-		
LED	Angle	Beam	ciency	cd/lm	Connector
Z5	sim:	Diffuser	-	-	-
XP-E	12 deg	Diffuser	91 %	10.300	-
XP-E2	13 deg	Diffuser	86 %	11.800	-
XP-G2	15 deg	Diffuser	90 %	8.000	-
XT-E	16 deg	Diffuser	-	6.170	-
XP-G	17 deg	Diffuser	91 %	5.520	-
H35C1 (LEMWA33)	17 deg	Diffuser	86 %	7.200	-

Luminaire: Ledil Oy CA11420_TINA2-D (CREE XP-E2 (92 Im @ 250 mA)) Efficiency=86% Lamps: 1 x CREE XP-E2 (92 Im @ 250 mA)

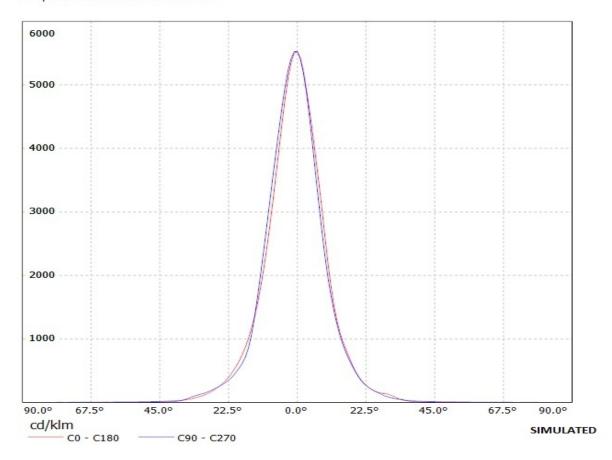


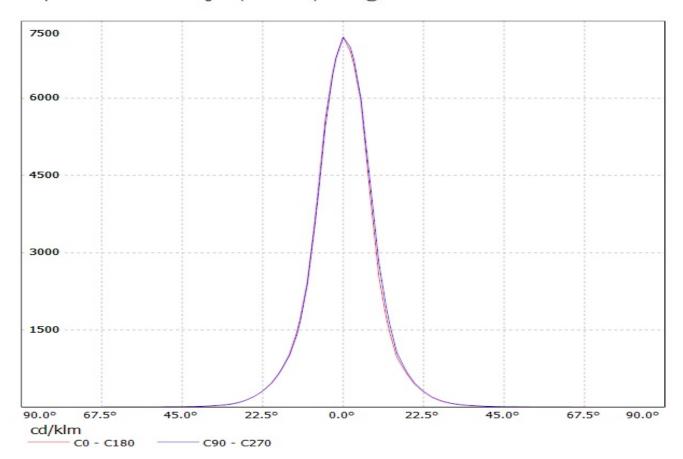
Valaisin: LEDIL OY CA11420_TINA2-D_(XP-G2) Efficiency=90% Lamput: 1 x Cree XP-G2 (109.1lm @ 250mA)



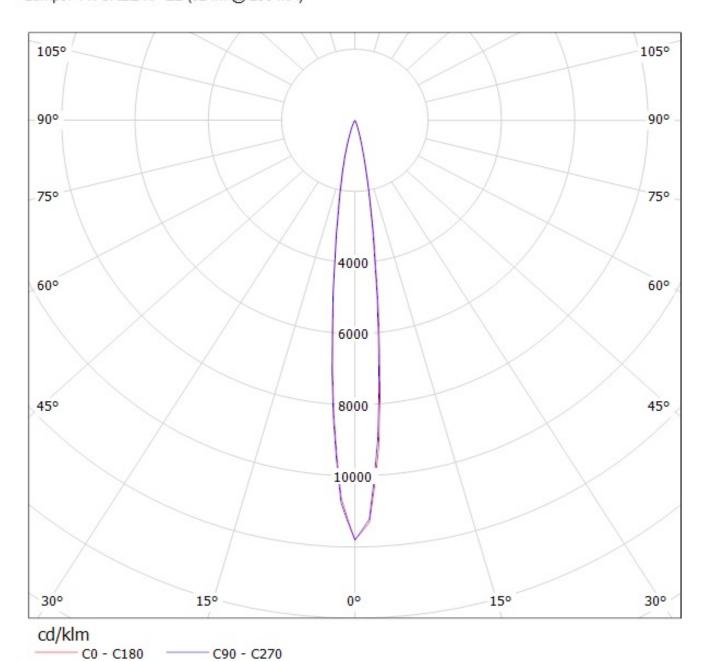


Luminaire: Ledil Oy CA11420_Tina2-XP-G-D-black LOR=95% Lamps: 1 x Cree XP-G 89Im 250mA

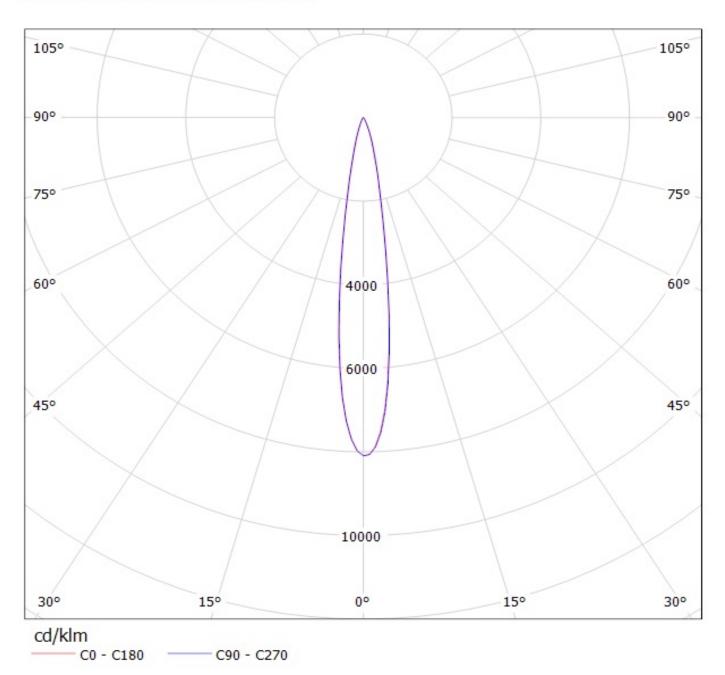


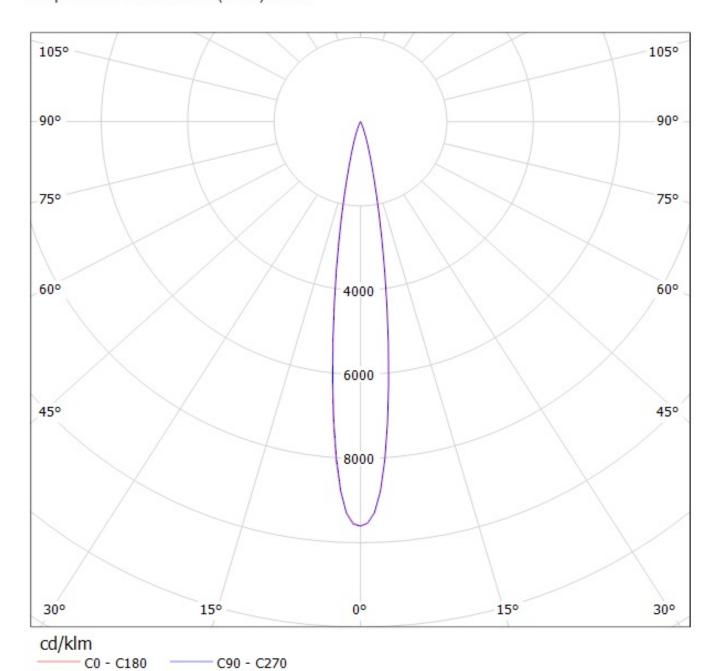


Luminaire: Ledil Oy CA11420_TINA2-D (CREE XP-E2 (92 lm @ 250 mA)) Efficiency=86% Lamps: 1 x CREE XP-E2 (92 lm @ 250 mA)

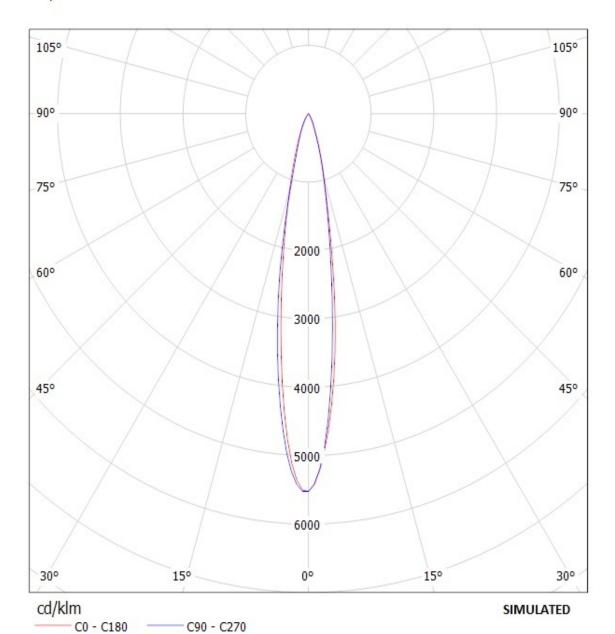


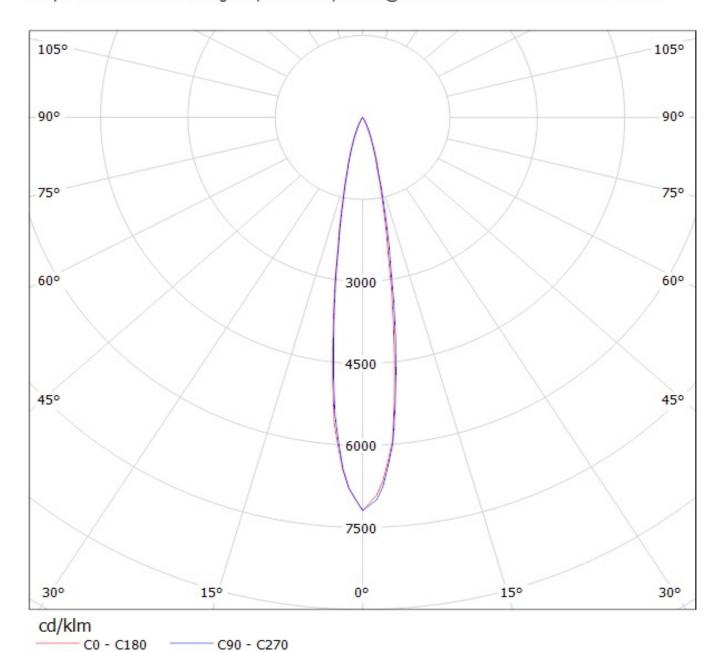
Valaisin: LEDIL OY CA11420_TINA2-D_(XP-G2) Efficiency=90% Lamput: 1 x Cree XP-G2 (109.1lm @ 250mA)





Luminaire: Ledil Oy CA11420_Tina2-XP-G-D-black LOR=95% Lamps: 1 x Cree XP-G 89Im 250mA





NOTE: The typical divergence will be changed by different color, chip size and chip position tolerance. The typical total divergence is the full angle measured where the luminous intensity is half of the peak value.

GENERAL INFORMATION

- Product series especially designed & optimized for series of LEDs.
- Special care taken to make light distribution as uniform as possible.
- Fastening to heat sink with a PU foam adhesive tape of automotive grade. Please find fastening details by clicking link: http://www.ledil.com/datasheets/DataSheet_TAPE.pdf
- NOTE 1: We advise customer to ensure the suitability and sufficiency of the bond in the end product. For example, mechanical stress, vibration and holes on the surface of the circuit boar weaken the strength of the tape.
- NOTE 2: Assembly to the surface must be made straight, so the tape bonds constant and balanced with fastening surface. Slanted assembly might cause unbalanced bond to the surface. All surfaces where tape is applied must be clean, dry and free from grease and dirt.

If cleaning of PCB surfaces is needed, please follow strictly the cleaning instructions of your LED manufacturer - this is important as cleaning shall under no circumstances damage LEDs or other electronics components on the PCB.

Further note that optical components shall not be cleaned with any chemicals - only micro fiber cloth may be used to remove fingerprints or other traces from handling.